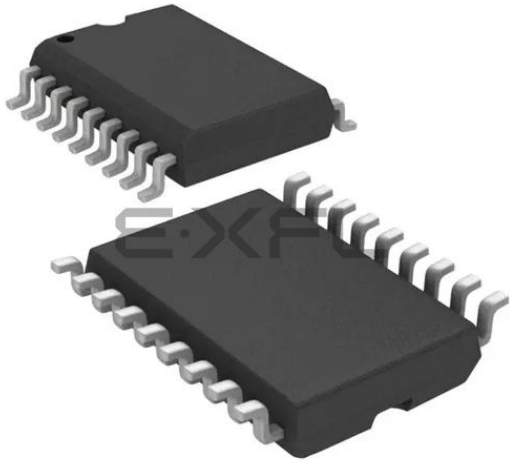

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Number of I/O	16
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Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
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Supplier Device Package	18-SOIC
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3.2.2 SPECIAL FUNCTION REGISTERS

The SFRs are registers used by the CPU and Peripheral functions for controlling the desired operation of the device (Table 3-1). These registers are static RAM.

The special registers can be classified into two sets (core and peripheral). The SFRs associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

TABLE 3-1: SPECIAL REGISTERS SUMMARY BANK 0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset(1)	Details on Page
Bank 0											
00h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	25
01h	TMR0	Timer0 Module's Register								xxxx xxxx	43
02h	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	13
03h	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	19
04h	FSR	Indirect data memory address pointer								xxxx xxxx	25
05h	PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx 0000	29
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	34
07h	—	Unimplemented								—	—
08h	—	Unimplemented								—	—
09h	—	Unimplemented								—	—
0Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	25
0Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	21
0Ch	PIR1	EEIF	CMIF	RCIF	TXIF	—	CCP1IF	TMR2IF	TMR1IF	0000 -000	23
0Dh	—	Unimplemented								—	—
0Eh	TMR1L	Holding register for the Least Significant Byte of the 16-bit TMR1								xxxx xxxx	46
0Fh	TMR1H	Holding register for the Most Significant Byte of the 16-bit TMR1								xxxx xxxx	46
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{T1SYNC}$	TMR1CS	TMR1ON	--00 0000	46
11h	TMR2	TMR2 module's register								0000 0000	50
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	50
13h	—	Unimplemented								—	—
14h	—	Unimplemented								—	—
15h	CCPR1L	Capture/Compare/PWM register (LSB)								xxxx xxxx	61
16h	CCPR1H	Capture/Compare/PWM register (MSB)								xxxx xxxx	61
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	61
18h	RCSTA	SPEN	RX9	SREN	CREN	ADEN	FERR	OERR	RX9D	0000 -00x	67
19h	TXREG	USART Transmit data register								0000 0000	74
1Ah	RCREG	USART Receive data register								0000 0000	77
1Bh	—	Unimplemented								—	—
1Ch	—	Unimplemented								—	—
1Dh	—	Unimplemented								—	—
1Eh	—	Unimplemented								—	—
1Fh	CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0000	53

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: For the Initialization Condition for Registers Tables, refer to Table 14-7 and Table 14-8 on page 98.

3.2.2.2 OPTION Register

The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the external RB0/INT interrupt, TMR0, and the weak pull-ups on PORTB.

Note:	To achieve a 1:1 prescaler assignment for TMR0, assign the prescaler to the WDT (PSA = 1). See Section 6.3.1

REGISTER 3-2: OPTION REGISTER (ADDRESS: 81h, 181h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
bit 7							bit 0

bit 7 **$\overline{\text{RBPU}}$**: PORTB Pull-up Enable bit
1 = PORTB pull-ups are disabled
0 = PORTB pull-ups are enabled by individual port latch values

bit 6 **INTEDG**: Interrupt Edge Select bit
1 = Interrupt on rising edge of RB0/INT pin
0 = Interrupt on falling edge of RB0/INT pin

bit 5 **T0CS**: TMR0 Clock Source Select bit
1 = Transition on RA4/T0CKI pin
0 = Internal instruction cycle clock (CLKOUT)

bit 4 **T0SE**: TMR0 Source Edge Select bit
1 = Increment on high-to-low transition on RA4/T0CKI pin
0 = Increment on low-to-high transition on RA4/T0CKI pin

bit 3 **PSA**: Prescaler Assignment bit
1 = Prescaler is assigned to the WDT
0 = Prescaler is assigned to the Timer0 module

bit 2-0 **PS2:PS0**: Prescaler Rate Select bits

Bit Value	TMR0 Rate	WDT Rate
000	1 : 2	1 : 1
001	1 : 4	1 : 2
010	1 : 8	1 : 4
011	1 : 16	1 : 8
100	1 : 32	1 : 16
101	1 : 64	1 : 32
110	1 : 128	1 : 64
111	1 : 256	1 : 128

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

3.2.2.3 INTCON Register

The INTCON register is a readable and writable register which contains the various enable and flag bits for all interrupt sources except the comparator module. See Section 3.2.2.4 and Section 3.2.2.5 for a description of the comparator enable and flag bits.

Note:	Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

REGISTER 3-3: INTCON REGISTER (ADDRESS: 0Bh, 8Bh, 10Bh, 18Bh)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF
bit 7							bit 0

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all unmasked interrupts
0 = Disables all interrupts

bit 6 **PEIE**: Peripheral Interrupt Enable bit
1 = Enables all unmasked peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **T0IE**: TMR0 Overflow Interrupt Enable bit
1 = Enables the TMR0 interrupt
0 = Disables the TMR0 interrupt

bit 4 **INTE**: RB0/INT External Interrupt Enable bit
1 = Enables the RB0/INT external interrupt
0 = Disables the RB0/INT external interrupt

bit 3 **RBIE**: RB Port Change Interrupt Enable bit
1 = Enables the RB port change interrupt
0 = Disables the RB port change interrupt

bit 2 **T0IF**: TMR0 Overflow Interrupt Flag bit
1 = TMR0 register has overflowed (must be cleared in software)
0 = TMR0 register did not overflow

bit 1 **INTF**: RB0/INT External Interrupt Flag bit
1 = The RB0/INT external interrupt occurred (must be cleared in software)
0 = The RB0/INT external interrupt did not occur

bit 0 **RBIF**: RB Port Change Interrupt Flag bit
1 = When at least one of the RB7:RB4 pins changed state (must be cleared in software)
0 = None of the RB7:RB4 pins have changed state

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

3.2.2.6 PCON Register

The PCON register contains flag bits to differentiate between a Power-on Reset, an external MCLR Reset, WDT Reset or a Brown-out Detect.

Note:	BOD is unknown on Power-on Reset. It must then be set by the user and checked on subsequent RESETS to see if BOD is cleared, indicating a brown-out has occurred. The BOD STATUS bit is a “don't care” and is not necessarily predictable if the brown-out circuit is disabled (by clearing the BODEN bit in the Configuration word).

REGISTER 3-6: PCON REGISTER (ADDRESS: 0Ch)

U-0	U-0	U-0	U-0	R/W-1	U-0	R/W-q	R/W-q
—	—	—	—	OSCF	—	POR	BOD
bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3 **OSCF**: INTRC/ER oscillator frequency
1 = 4 MHz typical(1)
0 = 37 KHz typical

bit 2 **Unimplemented:** Read as '0'

bit 1 **POR**: Power-on Reset STATUS bit
1 = No Power-on Reset occurred
0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)

bit 0 **BOD**: Brown-out Detect STATUS bit
1 = No Brown-out Reset occurred
0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

Note 1: When in ER Oscillator mode, setting OSCF = 1 will cause the oscillator frequency to change to the frequency specified by the external resistor.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

9.6 Comparator Interrupts

The Comparator Interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that has occurred. The CMIF bit, PIR1<6>, is the Comparator Interrupt Flag. The CMIF bit must be RESET by clearing '0'. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

The CMIE bit (PIE1<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

Note:	If a change in the CMCON register (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR1<6>) interrupt flag may not get set.

The user, in the interrupt service routine, can clear the interrupt in the following manner:

a) Any write or read of CMCON. This will end the mismatch condition.

b) Clear flag bit CMIF.

A mismatch condition will continue to set flag bit CMIF. Reading CMCON will end the mismatch condition, and allow flag bit CMIF to be cleared.

9.7 Comparator Operation During SLEEP

When a comparator is active and the device is placed in SLEEP mode, the comparator remains active and the interrupt is functional if enabled. This interrupt will wake-up the device from SLEEP mode when enabled. While the comparator is powered-up, higher SLEEP currents than shown in the power-down current specification will occur. Each comparator that is operational will consume additional current as shown in the comparator specifications. To minimize power consumption while in SLEEP mode, turn off the comparators, CM<2:0> = 111, before entering SLEEP. If the device wakes-up from SLEEP, the contents of the CMCON register are not affected.

9.8 Effects of a RESET

A device RESET forces the CMCON register to its RESET state. This forces the Comparator module to be in the comparator RESET mode, CM2:CM0 = 000. This ensures that all potential inputs are analog inputs. Device current is minimized when analog inputs are present at RESET time. The comparators will be powered-down during the RESET interval.

9.9 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 9-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to V_{DD} and V_{SS}. The analog input therefore, must be between V_{SS} and V_{DD}. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latchup may occur. A maximum source impedance of 10 kΩ is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

EXAMPLE 10-1: VOLTAGE REFERENCE CONFIGURATION

```
MOVLW   0x02        ; 4 Inputs Muxed
MOVWF   CMCON       ; to 2 comps.
BSF     STATUS,RP0  ; go to Bank 1
MOVLW   0x07        ; RA3-RA0 are
MOVWF   TRISA       ; outputs
MOVLW   0xA6        ; enable VREF
MOVWF   VRCON       ; low range
                    ; set VR<3:0>=6
BCF     STATUS,RP0  ; go to Bank 0
CALL    DELAY10     ; 10µs delay
```

10.2 Voltage Reference Accuracy/Error

The full range of VSS to VDD cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 10-1) keep VREF from approaching VSS or VDD. The Voltage Reference is VDD derived and therefore, the VREF output changes with fluctuations in VDD. The tested absolute accuracy of the Voltage Reference can be found in Table 17-2.

10.3 Operation During SLEEP

When the device wakes-up from SLEEP through an interrupt or a Watchdog Timer timeout, the contents of the VRCON register are not affected. To minimize current consumption in SLEEP mode, the Voltage Reference should be disabled.

10.4 Effects of a RESET

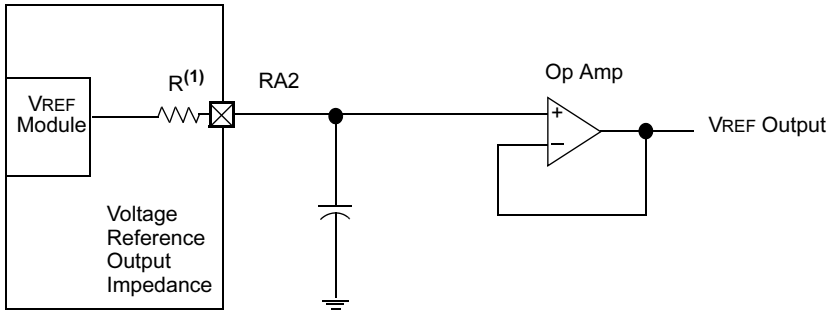
A device RESET disables the Voltage Reference by clearing bit VREN (VRCON<7>). This RESET also disconnects the reference from the RA2 pin by clearing bit VROE (VRCON<6>) and selects the high voltage range by clearing bit VRR (VRCON<5>). The VREF value select bits, VRCON<3:0>, are also cleared.

10.5 Connection Considerations

The Voltage Reference module operates independently of the Comparator module. The output of the reference generator may be connected to the RA2 pin if the TRISA<2> bit is set and the VROE bit, VRCON<6>, is set. Enabling the Voltage Reference output onto the RA2 pin with an input signal present will increase current consumption. Connecting RA2 as a digital output with VREF enabled will also increase current consumption.

The RA2 pin can be used as a simple D/A output with limited drive capability. Due to the limited drive capability, a buffer must be used in conjunction with the Voltage Reference output for external connections to VREF. Figure 10-2 shows an example buffering technique.

FIGURE 10-2: VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE



Note 1: R is dependent upon the Voltage Reference Configuration VRCON<3:0> and VRCON<5>.

TABLE 10-1: REGISTERS ASSOCIATED WITH VOLTAGE REFERENCE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value On POR	Value On All Other RESETS
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	000- 0000
1Fh	CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0000	0000 0000
85h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	1111 1111

Note 1: — = Unimplemented, read as '0'.

12.0 UNIVERSAL SYNCHRONOUS/ ASYNCHRONOUS RECEIVER/ TRANSMITTER (USART) MODULE

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI). The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc.

The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous - Master (half duplex)
- Synchronous - Slave (half duplex)

Bit SPEN (RCSTA<7>), and bits TRISB<2:1>, have to be set in order to configure pins RB2/TX/CK and RB1/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

REGISTER 12-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER (ADDRESS: 98h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D
bit 7							bit 0

bit 7 **CSRC**: Clock Source Select bit
Asynchronous mode
Don't care
Synchronous mode
1 = Master mode (Clock generated internally from BRG)
0 = Slave mode (Clock from external source)

bit 6 **TX9**: 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN**: Transmit Enable bit(1)
1 = Transmit enabled
0 = Transmit disabled

bit 4 **SYNC**: USART Mode Select bit
1 = Synchronous mode
0 = Asynchronous mode

bit 3 **Unimplemented:** Read as '0'

bit 2 **BRGH**: High Baud Rate Select bit
Asynchronous mode
1 = High speed
0 = Low speed
Synchronous mode
Unused in this mode

bit 1 **TRMT**: Transmit Shift Register STATUS bit
1 = TSR empty
0 = TSR full

bit 0 **TX9D**: 9th bit of transmit data. Can be PARITY bit.

Note 1: SREN/CREN overrides TXEN in SYNC mode.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

TABLE 12-3: BAUD RATES FOR SYNCHRONOUS MODE

BAUD RATE (K)	Fosc = 20 MHz		SPBRG value (decimal)	16 MHz		SPBRG value (decimal)	10 MHz		SPBRG value (decimal)
	KBAUD	ERROR		KBAUD	ERROR		KBAUD	ERROR	
0.3	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	NA	—	—
2.4	NA	—	—	NA	—	—	NA	—	—
9.6	NA	—	—	NA	—	—	9.766	+1.73%	255
19.2	19.53	+1.73%	255	19.23	+0.16%	207	19.23	+0.16%	129
76.8	76.92	+0.16%	64	76.92	+0.16%	51	75.76	-1.36%	32
96	96.15	+0.16%	51	95.24	-0.79%	41	96.15	+0.16%	25
300	294.1	-1.96	16	307.69	+2.56%	12	312.5	+4.17%	7
500	500	0	9	500	0	7	500	0	4
HIGH	5000	—	0	4000	—	0	2500	—	0
LOW	19.53	—	255	15.625	—	255	9.766	—	255

BAUD RATE (K)	Fosc = 7.15909 MHz		SPBRG value (decimal)	5.0688 MHz		SPBRG value (decimal)	4 MHz		SPBRG value (decimal)
	KBAUD	ERROR		KBAUD	ERROR		KBAUD	ERROR	
0.3	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	NA	—	—
2.4	NA	—	—	NA	—	—	NA	—	—
9.6	9.622	+0.23%	185	9.6	0	131	9.615	+0.16%	103
19.2	19.24	+0.23%	92	19.2	0	65	19.231	+0.16%	51
76.8	77.82	+1.32	22	79.2	+3.13%	15	75.923	+0.16%	12
96	94.20	-1.88	18	97.48	+1.54%	12	1000	+4.17%	9
300	298.3	-0.57	5	316.8	5.60%	3	NA	__	—
500	NA	—	—	NA	__	—	NA	—	—
HIGH	1789.8	—	0	1267	—	0	100	—	0
LOW	6.991	—	255	4.950	—	255	3.906	—	255

BAUD RATE (K)	Fosc = 3.579545 MHz		SPBRG value (decimal)	1 MHz		SPBRG value (decimal)	32.768 MHz		SPBRG value (decimal)
	KBAUD	ERROR		KBAUD	ERROR		KBAUD	ERROR	
0.3	NA	—	—	NA	—	—	0.303	+1.14%	26
1.2	NA	—	—	1.202	+0.16%	207	1.170	-2.48%	6
2.4	NA	—	—	2.404	+0.16%	103	NA	__	—
9.6	9.622	+0.23%	92	9.615	+0.16%	25	NA	—	—
19.2	19.04	-0.83%	46	19.24	+0.16%	12	NA	—	—
76.8	74.57	-2.90%	11	83.34	+8.51%	2	NA	—	__
96	99.43	+3.57%	8	NA	__	__	NA	__	—
300	298.3	0.57%	2	NA	—	—	NA	—	—
500	NA	__	—	NA	—	—		—	—
HIGH	894.9	—	0	250	—	0	8.192	—	0
LOW	3.496	—	255	0.9766	—	255	0.032	—	255

14.2.6 INTERNAL 4 MHz OSCILLATOR

The internal RC oscillator provides a fixed 4 MHz (nominal) system clock at VDD = 5V and 25°C, see "Electrical Specifications" section for information on variation over voltage and temperature.

14.2.7 CLKOUT

The PIC16F62X can be configured to provide a clock out signal by programming the configuration word. The oscillator frequency, divided by 4 can be used for test purposes or to synchronize other logic.

14.3 Special Feature: Dual Speed Oscillator Modes

A software programmable Dual Speed Oscillator mode is provided when the PIC16F62X is configured in either ER or INTRC Oscillator modes. This feature allows users to dynamically toggle the oscillator speed between 4 MHz and 37 kHz. In ER mode, the 4 MHz setting will vary depending on the value of the external resistor. Also in ER mode, the 37 kHz operation is fixed and does not vary with resistor value. Applications that require low current power savings, but cannot tolerate putting the part into SLEEP, may use this mode.

The OSCF bit in the PCON register is used to control Dual Speed mode. See Section 3.2.2.6, Register 3-4.

14.4 RESET

The PIC16F62X differentiates between various kinds of RESET:

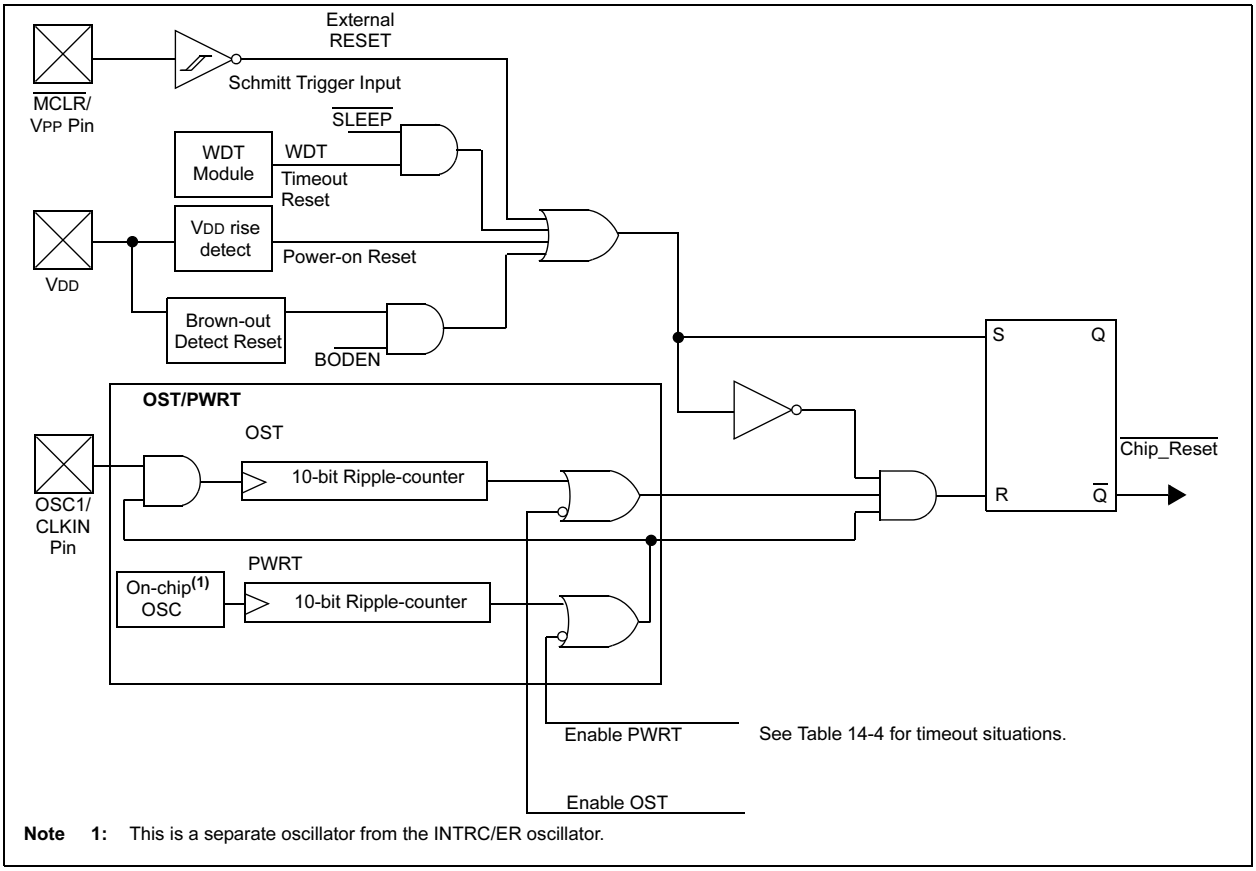
a) Power-on Reset (POR)
b) $\overline{MCLR}$ Reset during normal operation
c) $\overline{MCLR}$ Reset during SLEEP
d) WDT Reset (normal operation)
e) WDT Wake-up (SLEEP)
f) Brown-out Detect (BOD)

Some registers are not affected in any RESET condition; their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset, $\overline{MCLR}$ Reset, WDT Reset and $\overline{MCLR}$ Reset during SLEEP. They are not affected by a WDT Wake-up, since this is viewed as the resumption of normal operation. $\overline{TO}$ and $\overline{PD}$ bits are set or cleared differently in different RESET situations as indicated in Table 14-5. These bits are used in software to determine the nature of the RESET. See Table 14-8 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 14-6.

The $\overline{MCLR}$ Reset path has a noise filter to detect and ignore small pulses. See Table 17-6 for pulse width specification.

FIGURE 14-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: This is a separate oscillator from the INTRC/ER oscillator.

TABLE 14-7: INITIALIZATION CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	---- 1-0x
$\overline{MCLR}$ Reset during normal operation	000h	000u uuuu	---- 1-uu
$\overline{MCLR}$ Reset during SLEEP	000h	0001 0uuu	---- 1-uu
WDT Reset	000h	0000 uuuu	---- 1-uu
WDT Wake-up	PC + 1	uuu0 0uuu	---- u-uu
Brown-out Detect Reset	000h	000x xuuu	---- 1-u0
Interrupt Wake-up from SLEEP	PC + 1(1)	uuu1 0uuu	---- u-uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 14-8: INITIALIZATION CONDITION FOR REGISTERS

Register	Address	Power-on Reset	• $\overline{MCLR}$ Reset during normal operation • $\overline{MCLR}$ Reset during SLEEP • WDT Reset • Brown-out Detect Reset (1)	• Wake-up from SLEEP through interrupt • Wake-up from SLEEP through WDT timeout
W	—	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	00h	—	—	—
TMR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h	0000 0000	0000 0000	PC + 1(3)
STATUS	03h	0001 1xxx	000q quuu(4)	uuuq quuu(4)
FSR	04h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	05h	xxxx 0000	xxxx u000	xxxx 0000
PORTB	06h	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	10h	--00 0000	--uu uuuu	--uu uuuu
T2CON	12h	-000 0000	-000 0000	-uuu uuuu
CCP1CON	17h	--00 0000	--00 0000	--uu uuuu
RCSTA	18h	0000 -00x	0000 -00x	uuuu -uuu
CMCON	1Fh	0000 0000	0000 0000	uu-- uuuu
PCLATH	0Ah	---0 0000	---0 0000	---u uuuu
INTCON	0Bh	0000 000x	0000 000u	uuuu uqqq(2)
PIR1	0Ch	0000 -000	0000 -000	-q-- ----(2,5)
OPTION	81h	1111 1111	1111 1111	uuuu uuuu
TRISA	85h	11-1 1111	11-- 1111	uu-u uuuu
TRISB	86h	1111 1111	1111 1111	uuuu uuuu
PIE1	8Ch	0000 -000	0000 -000	uuuu -uuu
PCON	8Eh	---- 1-0x	---- 1-uq(1,6)	---- --uu
TXSTA	98h	0000 -010	0000 -010	uuuu -uuu
EECON1	9Ch	---- x000	---- q000	---- uuuu
VRCON	9Fh	000- 0000	000- 0000	uuu- uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If VDD goes too low, Power-on Reset will be activated and registers will be affected differently.
2: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).
3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).
4: See Table 14-7 for RESET value for specific condition.
5: If wake-up was due to comparator input changing, then Bit 6 = 1. All other interrupts generating a wake-up will cause Bit 6 = u.
6: If RESET was due to brown-out, then Bit 0 = 0. All other RESETS will cause Bit 0 = u.

BCF **Bit Clear f**

Syntax: [*label*] BCF f,b

Operands: $0 \le f \le 127$
$0 \le b \le 7$

Operation: $0 \rightarrow$ (f<b>)

Status Affected: None

Encoding:

01	00bb	bfff	ffff

Description: Bit 'b' in register 'f' is cleared.

Words: 1

Cycles: 1

Example
```
BCF     REG1, 7
```
Before Instruction
REG1 = 0xC7
After Instruction
REG1 = 0x47

BSF **Bit Set f**

Syntax: [*label*] BSF f,b

Operands: $0 \le f \le 127$
$0 \le b \le 7$

Operation: $1 \rightarrow$ (f<b>)

Status Affected: None

Encoding:

01	01bb	bfff	ffff

Description: Bit 'b' in register 'f' is set.

Words: 1

Cycles: 1

Example
```
BSF     REG1, 7
```
Before Instruction
REG1 = 0x0A
After Instruction
REG1 = 0x8A

BTFSC **Bit Test f, Skip if Clear**

Syntax: [*label*] BTFSC f,b

Operands: $0 \le f \le 127$
$0 \le b \le 7$

Operation: skip if (f<b>) = 0

Status Affected: None

Encoding:

01	10bb	bfff	ffff

Description: If bit 'b' in register 'f' is '0' then the next instruction is skipped.
If bit 'b' is '0' then the next instruction fetched during the current instruction execution is discarded, and a `NOP` is executed instead, making this a two-cycle instruction.

Words: 1

Cycles: 1**(2)**

Example
```
HERE    BTFSC   REG1
FALSE   GOTO    PROCESS_CODE
TRUE    •
        •
        •
```
Before Instruction
PC = address `HERE`
After Instruction
if REG<1> = 0,
PC = address `TRUE`
if REG<1>=1,
PC = address `FALSE`

CLRW **Clear W**

Syntax: [*label*] CLRW

Operands: None

Operation: 00h → (W)
1 → Z

Status Affected: Z

Encoding:

00	0001	0000	0011

Description: W register is cleared. Zero bit (Z) is set.

Words: 1

Cycles: 1

Example
```
CLRW
```
Before Instruction
W = 0x5A
After Instruction
W = 0x00
Z = 1

CLRWDT **Clear Watchdog Timer**

Syntax: [*label*] CLRWDT

Operands: None

Operation: 00h → WDT
0 → WDT prescaler,
1 → $\overline{TO}$
1 → $\overline{PD}$

Status Affected: $\overline{TO}$, $\overline{PD}$

Encoding:

00	0000	0110	0100

Description: CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. STATUS bits $\overline{TO}$ and $\overline{PD}$ are set.

Words: 1

Cycles: 1

Example
```
CLRWDT
```
Before Instruction
WDT counter = ?
After Instruction
WDT counter = 0x00
WDT prescaler = 0
$\overline{TO}$ = 1
$\overline{PD}$ = 1

COMF **Complement f**

Syntax: [*label*] COMF f,d

Operands: 0 ≤ f ≤ 127
d ∈ [0,1]

Operation: ($\bar{f}$) → (dest)

Status Affected: Z

Encoding:

00	1001	dfff	ffff

Description: The contents of register 'f' are complemented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example
```
COMF    REG1, 0
```
Before Instruction
REG1 = 0x13
After Instruction
REG1 = 0x13
W = 0xEC

DECF **Decrement f**

Syntax: [*label*] DECF f,d

Operands: 0 ≤ f ≤ 127
d ∈ [0,1]

Operation: (f) - 1 → (dest)

Status Affected: Z

Encoding:

00	0011	dfff	ffff

Description: Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example
```
DECF    CNT, 1
```
Before Instruction
CNT = 0x01
Z = 0
After Instruction
CNT = 0x00
Z = 1

IORLW **Inclusive OR Literal with W**

Syntax: [*label*] IORLW k

Operands: $0 \le k \le 255$

Operation: (W) .OR. k → (W)

Status Affected: Z

Encoding:

11	1000	kkkk	kkkk

Description: The contents of the W register is OR'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Example
```
IORLW   0x35
```
Before Instruction
W = 0x9A
After Instruction
W = 0xBF
Z = 0

IORWF **Inclusive OR W with f**

Syntax: [*label*] IORWF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (W) .OR. (f) → (dest)

Status Affected: Z

Encoding:

00	0100	dfff	ffff

Description: Inclusive OR the W register with register 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Example
```
IORWF   REG1, 0
```
Before Instruction
REG1 = 0x13
W = 0x91
After Instruction
REG1 = 0x13
W = 0x93
Z = 1

MOVLW **Move Literal to W**

Syntax: [*label*] MOVLW k

Operands: $0 \le k \le 255$

Operation: k → (W)

Status Affected: None

Encoding:

11	00xx	kkkk	kkkk

Description: The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.

Words: 1

Cycles: 1

Example
```
MOVLW   0x5A
```
After Instruction
W = 0x5A

MOVF **Move f**

Syntax: [*label*] MOVF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) → (dest)

Status Affected: Z

Encoding:

00	1000	dfff	ffff

Description: The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.

Words: 1

Cycles: 1

Example
```
MOVF    REG1, 0
```
After Instruction
W = value in REG1 register
Z = 1

17.0 ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings†

Ambient temperature under bias ..... -40 to +125°C

Storage temperature ..... -65°C to +150°C

Voltage on V_{DD} with respect to V_{SS} ..... -0.3 to +6.5V

Voltage on $\overline{MCLR}$ and RA4 with respect to V_{SS} ..... -0.3 to +14V

Voltage on all other pins with respect to V_{SS} ..... -0.3V to V_{DD} + 0.3V

Total power dissipation(1) ..... 800 mW

Maximum current out of V_{SS} pin ..... 300 mA

Maximum current into V_{DD} pin ..... 250 mA

Input clamp current, I_{IK} (V_I < 0 or V_I > V_{DD}) ..... ± 20 mA

Output clamp current, I_{OK} (Vo < 0 or Vo >V_{DD}) ..... ± 20 mA

Maximum output current sunk by any I/O pin ..... 25 mA

Maximum output current sourced by any I/O pin ..... 25 mA

Maximum current sunk by PORTA and PORTB ..... 200 mA

Maximum current sourced by PORTA and PORTB ..... 200 mA

Note 1: Power dissipation is calculated as follows: $P_{DIS} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD}-V_{OH}) \times I_{OH}\} + \sum(V_{OI} \times I_{OL})$

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note: Voltage spikes below V_{SS} at the $\overline{MCLR}$ pin, inducing currents greater than 80 mA, may cause latchup. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{MCLR}$ pin rather than pulling this pin directly to V_{SS}

17.2 DC Characteristics: PIC16F62X (Commercial, Industrial, Extended) PIC16LF62X (Commercial, Industrial)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended Operating voltage VDD range as described in DC spec Table 17-1 and Table 17-2				
Param. No.	**Sym**	**Characteristic/Device**	**Min**	**Typ†**	**Max**	**Unit**	**Conditions**
	VIL	**Input Low Voltage**					
		I/O ports					
D030		with TTL buffer	VSS	—	0.8	V	VDD = 4.5V to 5.5V
					0.15 VDD	V	otherwise
D031		with Schmitt Trigger input	VSS		0.2 VDD	V	
D032		$\overline{MCLR}$, RA4/T0CKI,OSC1 (in ER mode)	VSS	—	0.2 VDD	V	**(Note1)**
D033		OSC1 (in XT and HS)	VSS	—	0.3 VDD	V	
		OSC1 (in LP)	VSS	—	0.6 VDD - 1.0	V	
	VIH	**Input High Voltage**					
		I/O ports					
D040		with TTL buffer	2.0V	—	VDD	V	VDD = 4.5V to 5.5V
			.25 VDD + 0.8V		VDD	V	otherwise
D041		with Schmitt Trigger input	0.8 VDD	—	VDD	V	
D042		$\overline{MCLR}$ RA4/T0CKI	0.8 VDD	—	VDD	V	
D043		OSC1 (XT, HS and LP)	0.7 VDD	—	VDD	V	
D043A		OSC1 (in ER mode)	0.9 VDD			V	**(Note1)**
D070	IPURB	**PORTB weak pull-up current**	50	200	400	µA	VDD = 5.0V, VPIN = VSS
	IIL	**Input Leakage Current(2), (3)**					
		I/O ports (Except PORTA)			±1.0	µA	VSS ≤ VPIN ≤ VDD, pin at hi-impedance
D060		PORTA	—	—	±0.5	µA	VSS ≤ VPIN ≤ VDD, pin at hi-impedance
D061		RA4/T0CKI	—	—	±1.0	µA	VSS ≤ VPIN ≤ VDD
D063		OSC1, $\overline{MCLR}$	—	—	±5.0	µA	VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
	VOL	**Output Low Voltage**					
D080		I/O ports	—	—	0.6	V	IOL=8.5 mA, VDD=4.5V, -40° to +85°C
			—	—	0.6	V	IOL=7.0 mA, VDD=4.5V, +125°C
D083		OSC2/CLKOUT (ER only)	—	—	0.6	V	IOL=1.6 mA, VDD=4.5V, -40° to +85°C
			—	—	0.6	V	IOL=1.2 mA, VDD=4.5V, +125°C
	VOH	**Output High Voltage(3)**					
D090		I/O ports (Except RA4)	VDD - 0.7	—	—	V	IOH=-3.0 mA, VDD=4.5V, -40° to +85°C
			VDD - 0.7	—	—	V	IOH=-2.5 mA, VDD=4.5V, +125°C
D092		OSC2/CLKOUT (ER only)	VDD - 0.7	—	—	V	IOH=-1.3 mA, VDD=4.5V, -40° to +85°C
			VDD - 0.7	—	—	V	IOH=-1.0 mA, VDD=4.5V, +125°C
D150	VOD	**Open-Drain High Voltage**		—	8.5	V	RA4 pin PIC16F62X, PIC16LF62X*
		Capacitive Loading Specs on Output Pins					
D100*	COSC2	OSC2 pin		—	15	pF	In XT, HS and LP modes when external clock used to drive OSC1.
D101*	Cio	All I/O pins/OSC2 (in ER mode)		—	50	pF	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In ER oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16F62X be driven with external clock in ER mode.

2: The leakage current on the $\overline{MCLR}$ pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

FIGURE 17-7: CLKOUT AND I/O TIMING

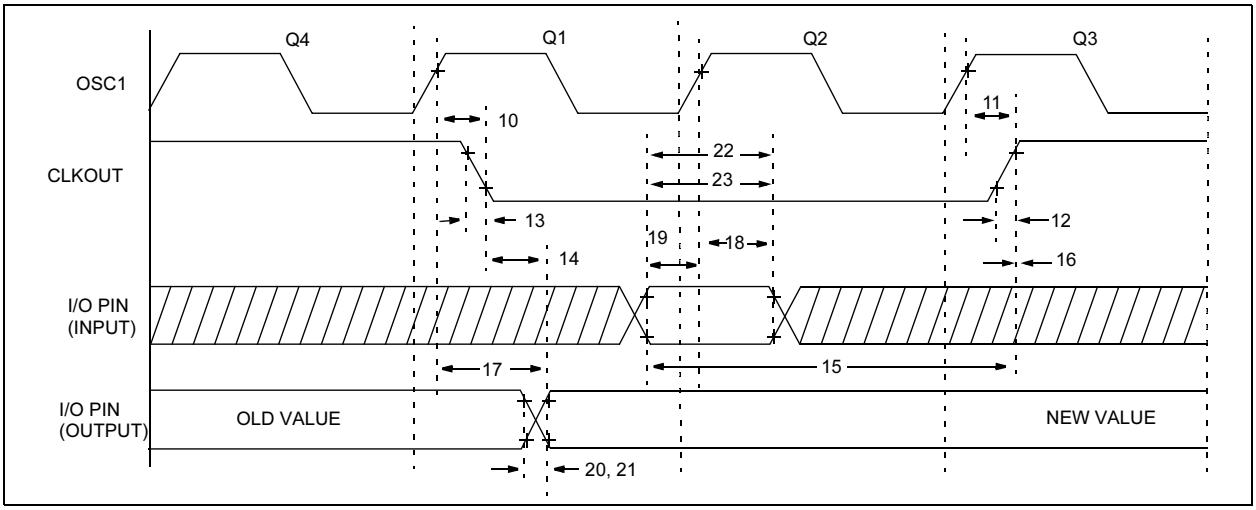


TABLE 17-5: CLKOUT AND I/O TIMING REQUIREMENTS

Param No.	Sym	Characteristic		Min	Typ†	Max	Units
10*	TosH2ckL	OSC1↑ to CLKOUT↓	16F62X	—	75	200	ns
10A*			16LF62X	—	—	400	ns
11*	TosH2ckH	OSC1↑ to CLKOUT↑	16F62X	—	75	200	ns
11A*			16LF62X	—	—	400	ns
12*	TckR	CLKOUT rise time	16F62X	—	35	100	ns
12A*			16LF62X	—	—	200	ns
13*	TckF	CLKOUT fall time	16F62X	—	35	100	ns
13A*			16LF62X	—	—	200	ns
14*	TckL2ioV	CLKOUT ↓ to Port out valid		—	—	20	ns
15*	TioV2ckH	Port in valid before	16F62X	Tosc+200 ns	—	—	ns
		CLKOUT ↑	16LF62X	Tosc=400 ns	—	—	ns
16*	TckH2ioI	Port in hold after CLKOUT ↑		0	—	—	ns
17*	TosH2ioV	OSC1↑ (Q1 cycle) to	16F62X	—	50	150*	ns
		Port out valid	16LF62X	—	—	300	ns
18*	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)		100 200	—	—	ns

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note: The graphs and tables provided in this section are for design guidance and are not tested.

FIGURE 18-6: MAXIMUM IDD vs FOSC OVER VDD (LP MODE)

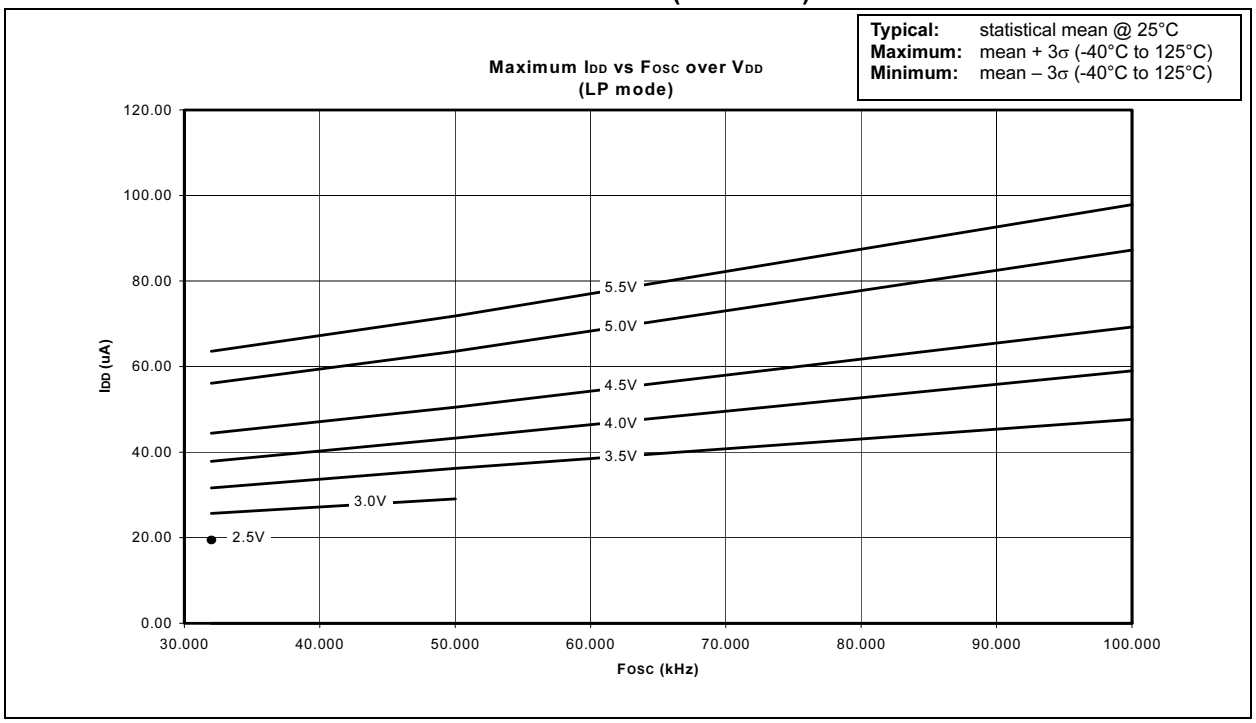
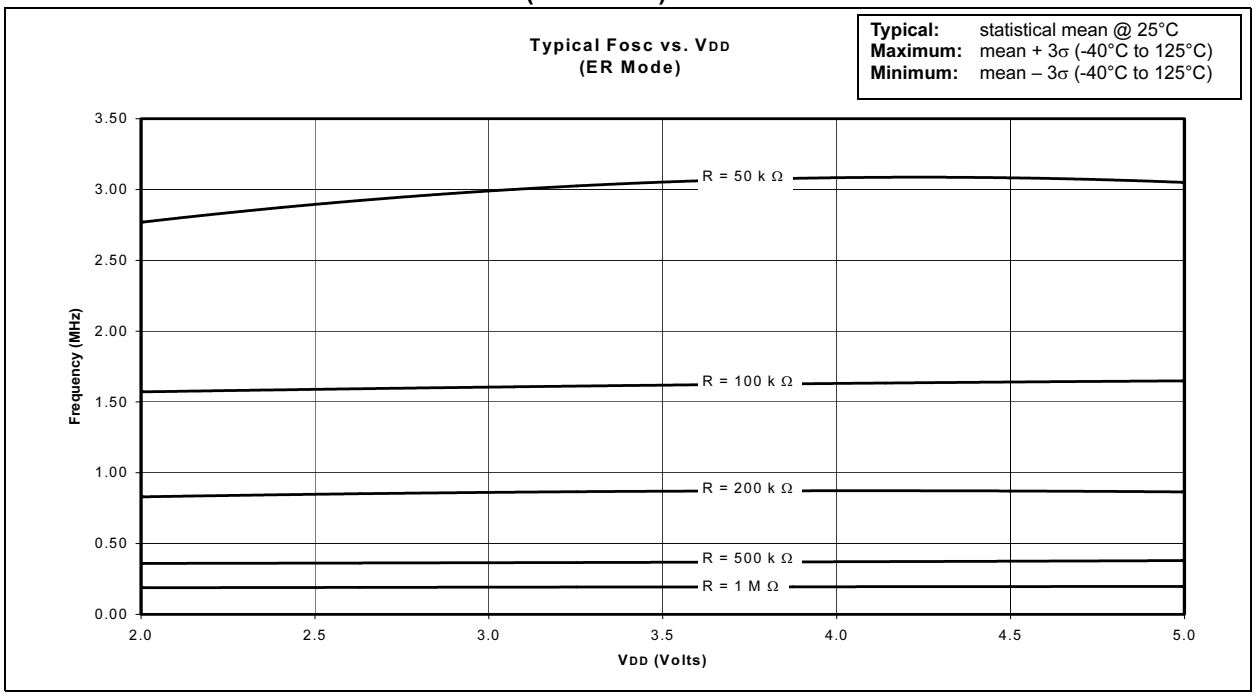
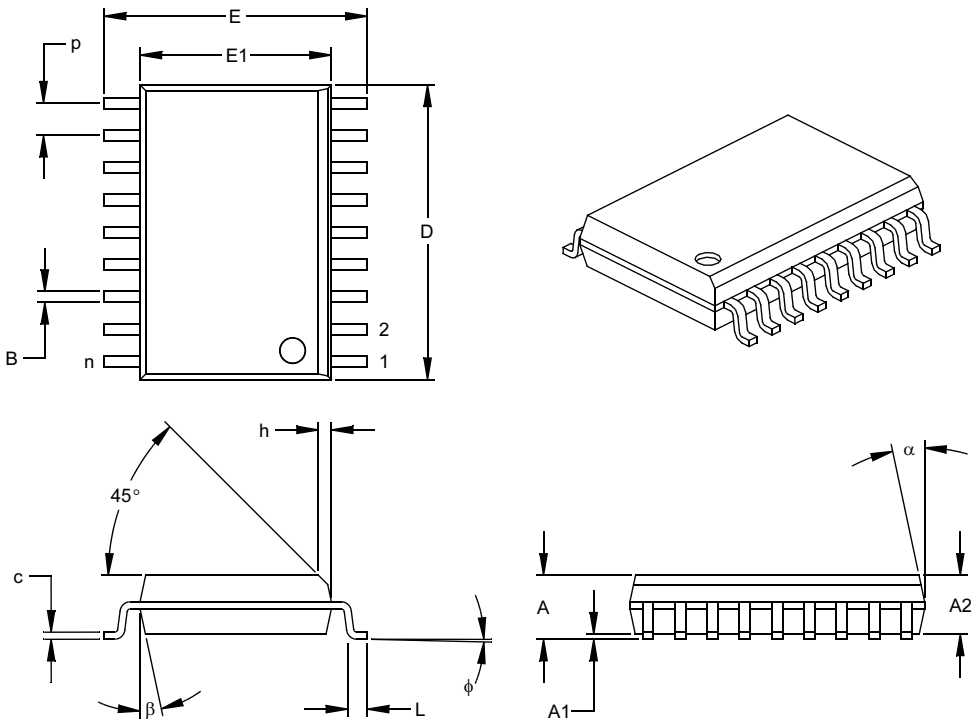


FIGURE 18-7: TYPICAL FOSC vs VDD (ER MODE)



K04-051 18-Lead Plastic Small Outline (SO) – Wide, 300 mil



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.050			1.27	
Overall Height	A	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	E	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.291	.295	.299	7.39	7.49	7.59
Overall Length	D	.446	.454	.462	11.33	11.53	11.73
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle	ϕ	0	4	8	0	4	8
Lead Thickness	c	.009	.011	.012	0.23	0.27	0.30
Lead Width	B	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-013
Drawing No. C04-051

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